

AERONAUTICAL MATERIAL SPECIFICATIONS

AMS 3598

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Revised

PLASTIC SHEET, COPPER FACED Glass Fabric Reinforced Polytetrafluoroethylene

1. **ACKNOWLEDGMENT:** A vendor shall mention this specification number in all quotations and when acknowledging purchase orders.
2. **APPLICATION:** Primarily for use in etched, printed circuits used in electrical and electronic equipment where continuous operating temperature will not exceed 400 F.
3. **MATERIAL AND FABRICATION:** The sheets shall be constructed of laminations of glass fabric thoroughly impregnated with a polytetrafluoroethylene resin and properly sintered. Face sheets of copper may be applied to one or both faces during the original sintering of the laminate or in subsequent operation.
4. **TECHNICAL REQUIREMENTS:**
 - 4.1 **General:**
 - 4.1.1 **Color:** Unless otherwise specified, the color of the plastic laminate shall be natural.
 - 4.1.2 **Copper Faces:** The facing material shall be electrolytically deposited copper of not less than 99.50% purity.
 - 4.2 **Properties:** Unless otherwise specified, the product shall conform to the following requirements; tests shall be performed on the product supplied and in accordance with listed ASTM methods, insofar as practicable. Specimens shall be conditioned in accordance with ASTM D618-54, Procedure A, prior to testing. For specimens requiring removal of copper faces prior to testing, the conditioning shall be performed after such removal.

4.2.1	Flexural Strength, flatwise, psi, min		ASTM D790-49T (See Note 1)
	Lengthwise	13,000	
	Crosswise	11,000	
4.2.2	Compressive Strength, flatwise, psi, min	19,000	ASTM D229-49 (See Note 1)
4.2.3	Water Absorption in 24 hr, %, max		ASTM D570-57T
	Nominal Thickness, in. (See Note 2)		(See Note 1)
	0.031	0.25	
	0.062	0.10	
	0.125	0.05	

use by anyone engaged in industry or trade is entirely voluntary. There is no assignment to adhere to any SAE standard or recommended practice, and no commitment to conform to or be guided by any technical report. In formulating and approving technical reports, the Board and its Committees will not investigate or consider patents which may apply to the subject matter. Prospective users of the report are responsible for protecting themselves against liability for infringement of patents.

4.2.4	Dielectric Strength, when specified, perpendicular to laminations, short time, v per mil, min Nominal Thickness, in. (See Note 2)		ASTM D149-55T (See Note 1)
	0.031	800	
	0.062	700	
	0.125	600	
4.2.5	Dielectric Strength parallel to laminations, step by step, kv per in., min As received After 48 hr immersion in distilled water at 122 F + 4		ASTM D229-49 Tentative Revision June 1951, Section 27c (See Note 1)
		32	
		10	
4.2.6	Dielectric Constant at 1 megacycle, max	2.9	ASTM D150-54T (See Note 1)
4.2.7	Power Factor at 1 megacycle, max	0.0006	ASTM D150-54T (See Note 1)
4.2.8	Arc Resistance, sec, min	150	ASTM D495-56T (See Note 1)
4.2.9	Solder Bath Resistance	Pass	See Note 3
4.2.10	Bond Strength, lb per in. width, min Nominal Foil Thickness, in. 0.0014 As received After solder float 0.0028 As received After solder float		See Note 4
		4	
		4	
		5	
		5	
4.2.11	Insulation Resistance, megohms, min	1,000	See Note 5
4.2.12	Solvent Resistance	Pass	See Note 6
4.2.13	Heat Resistance	Pass	See Note 7
4.2.14	Copper Porosity	Pass	See Note 8

Note 1. Removal of Copper: Prior to testing, specimens shall be immersed in vigorously aerated 40 deg Baume ferric chloride solution at 75 - 100 F until unwanted copper is removed. Solution shall be renewed when time of removal exceeds 15 min. per 0.0014 in. thickness of copper. After removal of copper, specimens shall immediately be rinsed for 1 hr in running water at 60 - 90 F

Note 2. For thicknesses not specified, use the value for the next lower thickness.

Note 3. Solder Bath Resistance: Three etched specimens 1 in. square by the thickness of the material shall be tested. The specimens shall be dipped in liquid flux (rosin in alcohol) and then floated on the surface of a bath of molten solder, with the copper face to be tested down. The solder shall be at a temperature of 490 F \pm 10. After 20 sec, the specimens shall be removed from the solder bath and examined. The material shall not soften, split, blister, or delaminate. For material with copper on both sides, three specimens shall be tested for each side.

Note 4. Bond Strength: The strength of the bond between the copper foil and the base laminate shall be determined at 70 - 85 F in accordance with the following procedure on specimens as received and on specimens which have been floated on molten solder in accordance with Note 3. Etch four 1 x 4 in. specimens, two in the lengthwise direction and two in the crosswise direction, in accordance with Note 1. Grasp the test specimen, on each end, between the thumbs and forefingers and flex each side of the specimen 5 times. During flexing, the center of the specimen shall deflect at least 1/4 in. beyond the ends (flexing of specimens over 0.093 in. thick is not required). The copper foil shall be peeled back from one end of the specimen for approximately 2 in., with the line of peel perpendicular to the edge of the specimen. The specimen shall be supported in a horizontal plane with the peeled copper strip down between two solid supports adjusted to provide a 3/4 in. span. The end of the peeled strip shall then be clamped between two rubberfaced jaws. The jaws shall cover the full width of the strip and shall be clamped parallel to the line of peel. The load shall be applied to the gripping tab, starting with no load, at a uniform rate not to exceed 2 in. per minute. The direction of the load applied to the tab shall not deviate from the perpendicular by more than 5 degrees. The load required to produce separation of the copper foil from the base material shall be recorded as the bond strength. The full width of the strip shall peel, otherwise the results shall be discarded and the test repeated. For sheets that are copper faced on both sides, eight specimens shall be tested, four on each side.

An alternate method of test follows: The specimen shall be supported in a horizontal plane with the peeled copper strip down between two solid supports adjusted to provide a 3/4 in. span. The end of the peeled strip shall then be clamped between rubber-faced jaws to which is attached a light container. The total weight of the clamp and the container shall not exceed 1 pound. The jaws shall cover the full width of the strip and shall be clamped parallel to the line of peel. Sand (or equivalent) shall be poured into the container at a rate of approximately 2 lb per min. until the strip begins to peel, and the container shall then be weighed. The full width of the strip shall peel, otherwise the results shall be discarded and the test repeated. For sheets that are copper faced on both sides, eight specimens shall be tested, four on each side.

Note 5. Insulation Resistance:

(a) Test Specimens, Circuit: Three test specimens 2 in. x 2 1/2 in. by the thickness of the material shall be made as shown in Figure 1, or be the equivalent.

- (b) Test Specimen Preparation: Apply suitable resist to each test panel and develop Figure 1 wiring pattern in accordance with best commercial practice. Remove unwanted copper in accordance with Note 1 except final rinse shall be for 15 - 20 minutes. Immediately remove iron salts by immersing the wet panel in 10% oxalic acid at room temperature for 5 - 10 min. with occasional agitation. Rinse panel for 1 hr in running water at 60 - 90 F and 15 - 20 min. in running water at 170 - 190 F. Dry for 2 - 2½ hr in a forced circulating air oven maintained at 150 - 180 F and cool in a desiccator to room temperature and approximately 50% relative humidity. Drill necessary holes and solder lead wires into the holes using a pencil-type soldering iron or gun and water-white, unactivated rosin flux, filling the hole with a plug of solder. Remove excess flux and other contaminants by rinsing in a clean mixture of 90% ethanol and 10% distilled water by volume. Air dry. Care should be exercised to avoid touching critical areas of the clean specimen with bare hands.
- (c) Insulation Resistance Measurement: Mount test specimens in a circulating-air humidity chamber (provided with suitable specimen lead wire insulators on the chamber) maintained at $92\% \pm 2$ RH and $149 \text{ F} \pm 4$ and expose for 18 hr ± 1 . Lower the humidity to $87\% \pm 2$ RH while holding the temperature constant and stabilize the specimens at this condition for 2 - 2¼ hours. Apply 500 v DC between terminal leads and maintain electrification time for 1 minute. Immediately thereafter, measure insulation resistance using a megohm bridge (General Radio Type 544B or equivalent). Measurements shall be performed while the RH is $87\% \pm 1$.

- Note 6. Solvent Resistance: A 1 x 6 in. specimen etched and rinsed in accordance with Note 1 and dried shall be degreased in trichlorethylene vapor for 1/2 min., sprayed with recirculated degreaser solvent for 1-1/2 min., and examined. The base laminate and residual surface adhesive shall show no delamination, softening, blistering, or lifting.
- Note 7. Heat Resistance: A 6 x 6 in. test specimen shall be supported vertically, on a non-metallic rack, in a horizontal-flow, air-circulating oven at $350 \text{ F} \pm 10$ for 1/2 hour. The plane of the test specimen shall be parallel to the air flow. At the end of this period the specimen shall be removed from the oven and immediately examined. There shall be no evidence of blistering.
- Note 8. Copper Porosity: One half of a standard size sheet shall be vapor degreased and air dried. Lightly scrub the copper surfaces with a slurry of pumice and water, rinse thoroughly, and air dry. Handle board so that the copper surfaces are free of fingerprints, dust, etc. Examine in a dark room, using ultra-violet light, for fluorescent resin spots. There shall be not more than 3 resin spots, spaced not less than 1 in. apart, for each 18 x 18 in. area of copper. No resin spot shall have an included area greater than that of a 1/2 in. diameter circle.
5. QUALITY: The product shall be uniform in quality and condition and free from blisters, cracks, holes, cuts, wrinkles, delamination, unbonded areas, corrosion, excess bonding material, and other imperfections. Discoloration of the copper faces shall not be considered objectionable. The bonded copper faces shall be of such smoothness as to present no visible evidence of the underlying glass fabric weave.

6. SIZES AND TOLERANCES:

6.1 Length and Width: Shall not vary more than + 1.0 in., -0 from that ordered except where test specimens have been removed; no more than 4 sq ft shall be cut from each thickness in a shipment for testing, and the size of the portion of material removed shall be stated on the outside of the package.

6.2 Thickness:

6.2.1 Copper face standard thicknesses and tolerances shall be as follows:

Nominal Thickness Inch	Tolerance, Inch	
	Plus	Minus
0.0014	0.0004	0.0002
0.0028	0.0007	0.0003

6.2.2 Sheet Thickness: The total thickness of the finished sheet, including copper faces, shall be in accordance with the following; unless otherwise specified, material conforming to the normal thickness tolerances shall be furnished. When other thicknesses are specified, the tolerance for the next greater thickness shall be used.

6.2.2.1 Normal Thickness Tolerances:

Nominal Thickness Inch	Tolerance, Inch, Plus and Minus			
	Copper on One Side Only		Copper on Both Sides	
	0.0014 in.	0.0028 in.	0.0014 in.	0.0028 in.
0.031	0.0065	0.0075	0.0075	0.0085
0.062	0.0075	0.0085	0.0085	0.0095
0.125	0.012	0.013	0.013	0.014

6.2.2.1.1 At least 90% of the sheet shall be within the tolerance given and at no point shall the thickness vary from the nominal thickness by a value greater than 125% of the specified tolerances.

6.2.2.2 Close Thickness Tolerances:

Nominal Thickness Inch	Tolerance, Inch, Plus and Minus			
	Copper on One Side Only		Copper on Both Sides	
	0.0014 in.	0.0028 in.	0.0014 in.	0.0028 in.
0.031	0.004	0.0045	0.0045	0.006
0.060	0.0055	0.006	0.006	0.007
0.125	0.008	0.008	0.008	0.010

6.2.2.2.1 Specified tolerances shall be furnished over 100% of the area of the sheet.

6.2.3 Warp and Twist: Shall not exceed the following values, based on 36 in. length, when determined in accordance with ASTM D229-49 or D709-55T:

Nominal Thickness Inch	Maximum Deviations, Inches		
	Copper on One Side Only		Copper on Both Sides
	0.0014 in.	0.0028 in.	Both Thickness
0.031 to 0.045, incl	7.2	8.64	2.16
Over 0.045 to 0.062, incl	5.4	6.48	2.16
Over 0.062 to 0.125, incl	3.6	4.32	1.08